From: Wyatt, Robert

To: <u>Chip Humphrey/R10/USEPA/US@EPA</u>

Subject: Re: EPA response to LWG February 5 2010 letter

**Date:** 02/11/2010 03:40 PM

Thanks Chip.

Bob

----- Original Message ----From: Humphrey.Chip@epamail.epa.gov <Humphrey.Chip@epamail.epa.gov>
To: Wyatt, Robert
Cc: jworonets@anchorqea.com <jworonets@anchorqea.com>
Sent: Thu Feb 11 15:39:06 2010
Subject: EPA response to LWG February 5 2010 letter

## Bob

Attached is our follow-up response to the LWG's proposal regarding PCB modeling for the fate and transport model as discussed yesterday. As noted in the letter, we are acknowledging the potential delays to the schedule, but would like to revisit the schedule impacts along with other work items (ie, the risk management "short" list) at our next Project Managers meeting.

Also, our respective technical teams will likely have some questions about some of the details of this modeling effort, and trust that we can have some additional discussion, if necessary, with minimal disruptions to the work.

Please let us know if you any questions about this letter.

thanks Chip Humphrey

(See attached file: EPAresponsePCBModelingApproach21110.pdf)